PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hsueh-Hao Shih	08/08/2013

RECEIVING PARTY DATA

Name:	UNITED MICROELECTRONICS CORP.
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park
City:	Hsin-Chu City
State/Country: TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13966294

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	KATE YEH
Signature:	/KATE YEH/
Date:	08/14/2013

Total Attachments: 2 source=1722795#page1.tif source=1722795#page2.tif

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PATENT

REEL: 031002 FRAME: 0970

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention: **SEMICONDUCTOR CAPACITOR**

As the below named inventor, I here This declaration is directed to:	by declare that:		•	
☐ The attached application, or				
☐ United States application number		filed on		, or
□ PCT international application number		filed on		
The above-identified application was	s made or authorized	to be made by me.		
I believe that I am the original invent application.	or or an original joint	inventor of a claime	ed invention	in the
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impr				ole
In consideration of the payment by	UNITED MICROE	LECTRONICS	having a p —	oostal address of
No.3, Li-Hsin Road 2, Science	e-Based Industria	l Park, Hsin-Chu	u City 300,	Taiwan, R.O.C
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good ar			receipt of w	hich is hereby
I hereby sell, assign and transfer to a the entire right, title and interest in a invention as above-identified applica- invention by the above application o substitutes, or extensions thereof, an	nd to any and all impr ation and, in and to, al r any continuations, c	ovements which ar I Letters Patent to I ontinuation-in-part,	e disclosed i be obtained f divisions, re	in the for said newals,
I hereby covenant that no assignme entered into which would conflict wit		· encumbrance has	been or will	be made or
I further covenant that ASSIGNEE wand documents relating to said inverknown and accessible to I and will to related thereto and will promptly exercise.	ntion and said Letters estify as to the same i	Patent and legal en any interference,	quivalents as litigation pro	s may be
representatives any and all papers, maintain, issue and enforce said appequivalents thereof which may be no IN WINTNESS WHEREOF, I have h	olication, said inventic ecessary or desirable	on and said Letters to carry out the pro	Patent and s	said
Note: An application data sheet (PT)				

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F#NPO-P0002E-US1201 DSC0-102U005740

Docket No NAUP1813USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

inventor:

Hsueh-Hao Shih

Date:

AUG 08 2013

Signature:

Househhaw This

NPO#NAU-P1813-USA:0 CUST#UMCD-2013-0145 Page 2 of 2

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PATENT

REEL: 031002 FRAME: 0972